

N-Channel Super Junction Power MOSFET ${\ensuremath{\mathrm{III}}}$

General Description

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

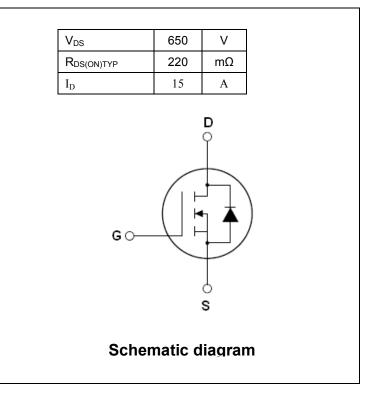
- •New technology for high voltage device
- •Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

Package Marking And Ordering Information						
Device Device Package Marking						
NCE65T260D	TO-263	NCE65T260D				
NCE65T260	TO-220	NCE65T260				
NCE65T260F	TO-220F	NCE65T260F				

Table 1. Absolute Maximum Ratings (T_c=25℃)





TO-263

TO-220

TO-220F

Parameter	Symbol	NCE65T260D NCE65T260	NCE65T260F	Unit
Drain-Source Voltage (VGs=0V)	VDS	65	50	V
Gate-Source Voltage (VDs=0V) AC (f>1 Hz)	Vgs	±30		V
Continuous Drain Current at Tc=25°C	I _{D (DC)}	15	15*	А
Continuous Drain Current at Tc=100°C	I _{D (DC)}	10	10*	А
Pulsed drain current (Note 1)	DM (pluse)	60	60*	А
Maximum Power Dissipation(Tc=25°C)	PD	131	33.2	W
Derate above 25°C		1.05	0.265	W/°C
Single pulse avalanche energy (Note 2)	Eas	30)4	mJ
Avalanche current ^(Note 1)	I _{AR}	3		А
Repetitive Avalanche energy , t_{AR} limited by T_{jmax} (Note 1)	E _{AR}	1	.6	mJ



NCE65T260D,NCE65T260,NCE65T260F

Parameter	Symbol	NCE65T260D NCE65T260	NCE65T260F	Unit
Drain Source voltage slope, $V_{DS} \leq 480 V$,	dv/dt	50		V/ns
Reverse diode dv/dt, $V_{DS} \leqslant 480 V, I_{SD} < I_D$	dv/dt	1	5	V/ns
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55	+150	°C

* limited by maximum junction temperature

Table 2. Thermal Characteristic

Parameter	Symbol	NCE65T260D NCE65T260	NCE65T260F	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R _{thJC}	0.95	3.76	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R _{thJA}	62	80	°C /W

Table 3.Electrical Characteristics (TA=25 $^{\circ}$ Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Мах	Unit	
On/off states							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	650			V	
Zero Gate Voltage Drain Current(Tc=25℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			1	μA	
Zero Gate Voltage Drain Current(Tc=125℃)	I _{DSS}	V _{DS} =650V,V _{GS} =0V			100	μA	
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V			±100	nA	
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	3	3.5	4	V	
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =8A		220	260	mΩ	
Dynamic Characteristics							
Input Capacitance	Clss			1210	1400	pF	
Output Capacitance	Coss	- V _{DS} =50V,V _{GS} =0V, F=1.0MHz		74		pF	
Reverse Transfer Capacitance	Crss			0.2		pF	
Total Gate Charge	Qg)/ -400)/1 -454		24.7	42	nC	
Gate-Source Charge	Q _{gs}	- V _{DS} =480V,I _D =15A, V _{GS} =10V		8.2		nC	
Gate-Drain Charge	Q _{gd}	- V _{GS} =10V		8.5		nC	
Switching times							
Turn-on Delay Time	t _{d(on)}			14		nS	
Turn-on Rise Time	tr	V _{DD} =380V,I _D =8A,		8		nS	
Turn-Off Delay Time	t _{d(off)}	R _G =2.3Ω,V _{GS} =10V		55		nS	
Turn-Off Fall Time	t _f			7		nS	
Source- Drain Diode Characteristics							
Source-drain current(Body Diode)	I _{SD}	T -25°0			15	А	
Pulsed Source-drain current(Body Diode)	I _{SDM}	T _C =25°C			60	А	
Forward On Voltage	V _{SD}	Tj=25°C,I _{SD} =15A,V _{GS} =0V		0.9	1.2	V	
Reverse Recovery Time	t _{rr}			240		nS	
Reverse Recovery Charge	Q _{rr}	Tj=25°C,I _F =7.5A,di/dt=100A/μs		2		uC	
Peak Reverse Recovery Current	I _{rrm}	1		17		А	

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R_G=25\Omega

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

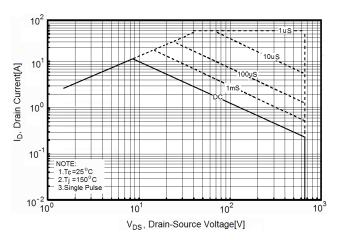


Figure3. Source-Drain Diode Forward Voltage

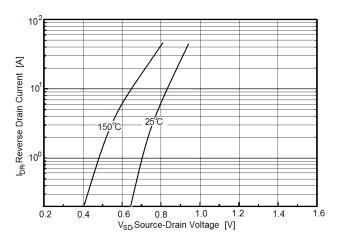


Figure5. Transfer characteristics

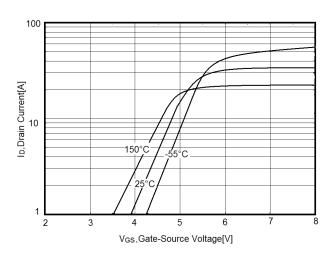
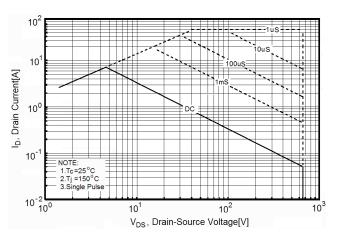
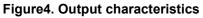


Figure2. Safe operating area for TO-220F





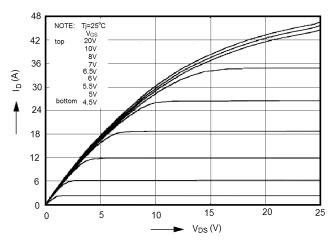
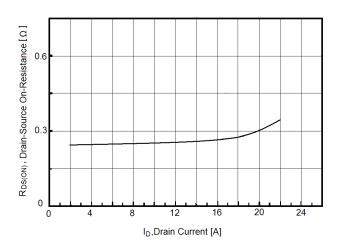


Figure6. Static drain-source on resistance



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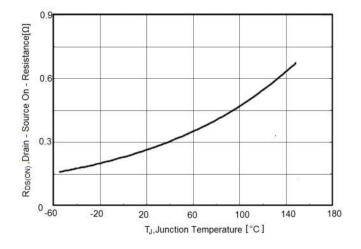


1.2

Vgs =0V I _ =250uA

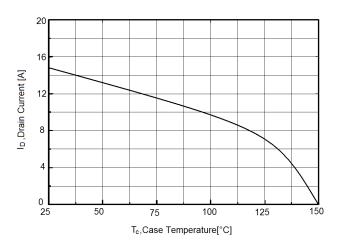
Figure7. R_{DS(ON)} vs Junction Temperature

Figure8. BV_{DSS} vs Junction Temperature

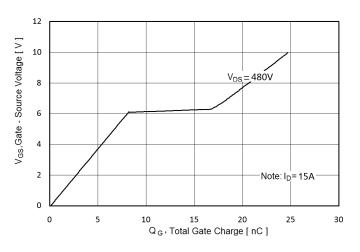


BV _{bss} (Normalized) , Drain - Source Breakdown Voltage .1 0.8 -100 -50 0 50 100 150 200 T_J,Junction Temperature [°C]

Figure9. Maximum I_D vs Junction Temperature









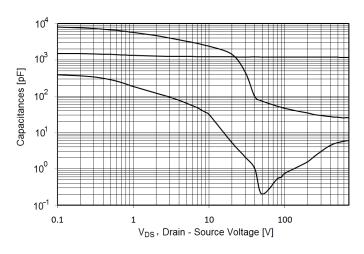
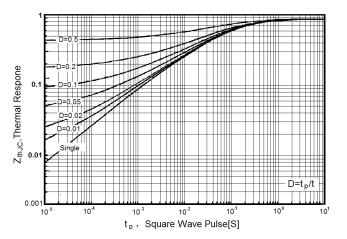


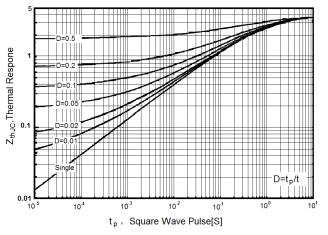
Figure12. Transient Thermal Impedance



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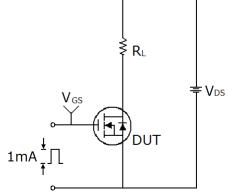
Figure13. Transient Thermal Impedance for TO-220F

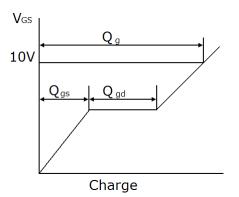




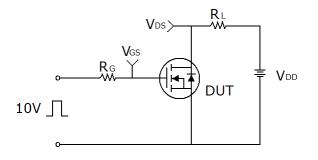
Test circuit

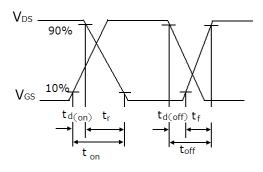
1) Gate charge test circuit & Waveform



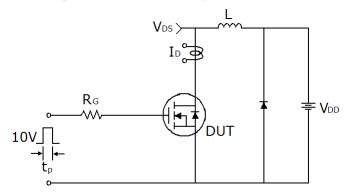


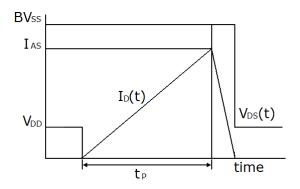
2) Switch Time Test Circuit:





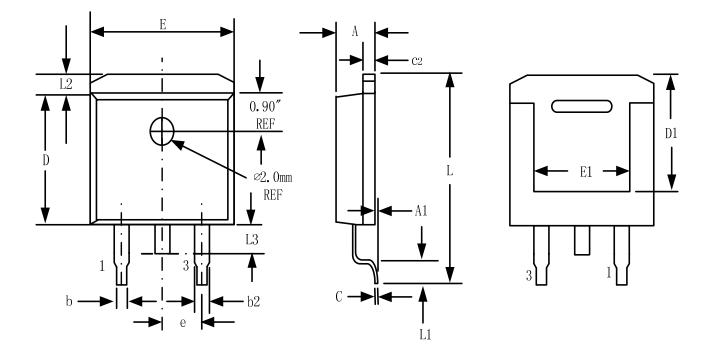
3) Unclamped Inductive Switching Test Circuit & Waveforms







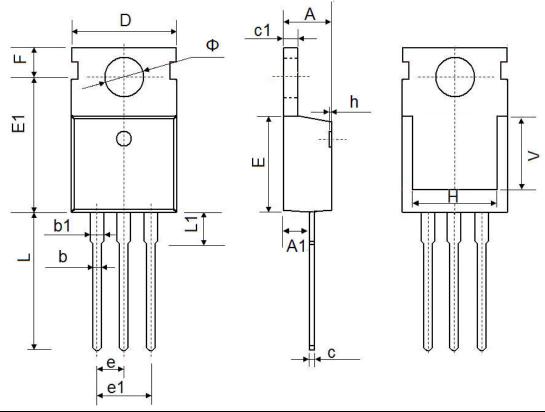
TO-263-3L Package Information



Symbol	Dimensions	Dimensions In Millimeters		s In Inches
Symbol	Min.	Max.	Min.	Max.
A	4.32	4.57	0.170	0.180
A1	-	0.25		0.010
b	0.71	0.94	0.028	0.037
b2	1.15	1.40	0.045	0.055
С	0.46	0.61	0.018	0.024
c2	1.22	1.40	0.048	0.055
D	8.89	9.40	0.350	0.370
D1	8.01	8.23	0.315	0.324
E	10.04	10.28	0.395	0.405
E1	7.88	8.08	0.310	0.318
е	2.5	4 BSC	0.100	BSC
L	14.73	15.75	0.580	0.620
L1	2.29	2.79	0.090	0.110
L2	1.15	1.39	0.045	0.055
L3	1.27	1.77	0.050	0.070



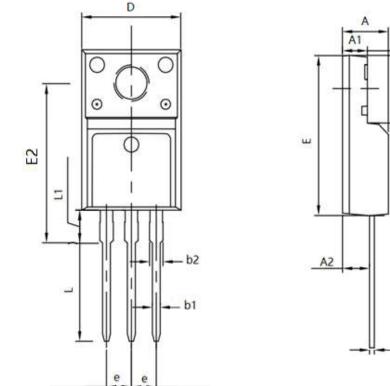
TO-220-3L-C Package Information

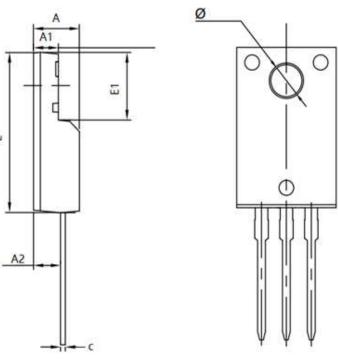


Sympol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
А	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.54) TYP.	0.100	TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		0.295	REF.	
Φ	3.400	3.800	0.134	0.150	



TO-220F Package Information





Symbol	Dimensions	n Millimeters	Dimension	s In Inches
	Min.	Max.	Min.	Max.
A	4.500	4.900	0.177	0.193
A1	2.340	2.740	0.092	0.108
A2	2.560	2.960	0.101	0.117
b1	0.700	0.900	0.028	0.035
b2	1.180	1.580	0.046	0.062
С	0.400	0.600	0.016	0.024
D	9.960	10.360	0.392	0.408
E	15.670	15.970	0.617	0.629
E1	6.500	6.900	0.256	0.272
E2	15.500	16.100	0.610	0.634
е	2.540	2.540 TYP) TYP
Φ	3.080	3.280	0.121	0.129
L	12.640	13.240	0.498	0.521
L1	3.030	3.430	0.119	0.135



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